

Product Specifications

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CHAMP .050 High Density Connector

English Connector, CHAMP, 050, Board-To-Board, Vertical and Right Angle Mounting **L** S_108-1367_B.tif English **Product Specification L**ENG_SS_108-1367_B.pdf English **LNG_SS_108-57876_A1.pdf** English Qualification Test Report **LNG_SS_**501-173_A.pdf English Connector, CHAMP, 050, Board To Board, Vertical & **Rt Angle Mounting L** S_501-173_A.tif English **Qualification Test Report** L JPN_SS_501-173_A.pdf Japanese MD_1734037-1_081820171154_dmtec Environmental LNG_PC_MD_1734037-1_D(029674).xlsx Compliance English MD_1734037-1_081820171154_dmtec LNG_PC_MD_1734037-1_D(560677).xml English Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity. Product Type PCB Connector Assembly Type : PCB Mount Receptacle Connector System : Board-to-Board Sealable : No Connector & Contact Terminates To: Printed Circuit Board Stackable : No Configuration Number of Rows: 4 PCB Mount Orientation : Right Angle Number of Positions : 80 Operating Voltage (VAC): 250 Insulation Resistance (M Ω): 4 Characteristics Dielectric Withstanding Voltage (Max) (VAC): 750 Connector Profile : Standard **Body Features** PCB Retention Feature Plating Material : Tin

PCB Retention Feature Material : Brass

Product

Features

Features

Electrical

Contact Features	Contact Base Material : Phosphor Bronze PCB Contact Termination Area Plating Material : Tin PCB Contact Termination Area Plating Material Finish : Matte PCB Contact Termination Area Plating Material Thickness : 3.81 µm [149.9997 µin] Contact Mating Area Plating Material : Gold Flash Contact Mating Area Plating Material Thickness (µin): 30 Contact Type : Socket Contact Current Rating (Max) (A): 1 Contact Layout : Matrix
Termination Features	Termination Post & Tail Length : 3.1 mm [.122 in] Termination Method to Printed Circuit Board : Through Hole - Solder
Mechanical Attachment	PCB Mount Retention Type : Boardlock Mating Alignment : With Mating Alignment Type : Polarized PCB Mount Retention : With PCB Mount Alignment : Without Connector Mounting Type : Board Mount
Housing Features	Centerline (Pitch) : 1.27 mm [.05 in] Housing Color : Black Housing Material : Matte
Dimensions	Connector Height : 7.65 mm [.300645 in]
Usage Conditions	Operating Temperature Range : -55 – 85 °C [-67 – 185 °F] Housing Temperature Rating : High
Operation/Application	ON Assembly Process Feature : None Circuit Application : Signal
Industry Standards	UL Flammability Rating : UL 94V-0
Packaging Features	Packaging Quantity : 21 Packaging Method : Package
Statement of Compliance	Statement of Compliance pdf

Also in the Series | CHAMP .050 Series I



Board-to-Board Headers & Receptacles (126)



Standard Rectangular Connectors (1)

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